Issue date: Jul. 02.09.

Specification

No. 9FT2R52Z1 — 1 to 12

Messrs. TVM

Electrolytic Capacitors

Specifications

Customer Part No. :	
Customer Specification No. :	Nippon Chemi-con Part No.: EKZH250ETD102MJ201
	emi-Con Corporation Con Iwate Corporation

T. Hino

Design Group Manager

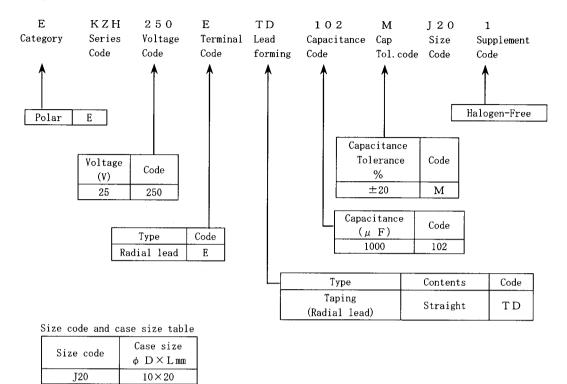
Receipt Stamp

1. Scope

This specification defines the requirements for aluminum electrolytic capacitors which comply with the first symbol W of JIS C 5141- 1991.

2. Part Numbering System

Example;



3. Rating

No.	Item	Specification	
1	Category temperature range	-40 to +105℃	
2	Rated voltage	25 Vpc	
3	Surge voltage	32 VDC	
4	Nominal capacitance	1000 μ F	+20℃, 120Hz
5	Capacitance tolerance	-20 to +20%	+20℃, 120Hz
6	Dissipation factor	0.14 max.	+20℃, 120Hz
7	Leakage current	250 μA max.	+20℃, after 2 minutes
8	Impedance	0.020 Ωmax.	+20℃, 100kHz
	Impedance	0.060 Ωmax.	−10°C, 100kHz
9	Rated ripple current	1960 mArms	+105°C, 100kHz

4. Performance

Unless otherwise specified, the capacitors shall be measured at +15 to +35°C, 45 to 75%RH and 86to 106kPa. However, if any doubt arises on the judgment, the measurement conditions shall be $\pm 20\pm2^{\circ}\text{C}$, 60 to 70%RH and 86 to 106kPa. The test conditions shall comply with JIS C 5102-1994.

4.1 Capacitance (Cap.)

[Conditions] Measuring frequency : $120 Hz \pm 20\%$

> Measuring voltage : 0.5Vrms max. +1.5 to 2.0VDC

Measuring circuit : Series equivalent circuit (O— | L-vv-o)

[Criteria] Shall be within the specified capacitance tolerance.

4.2 Dissipation factor $(\tan \delta)$

[Conditions] Measuring frequency

: $120 \text{Hz} \pm 20\%$

Measuring voltage

0.5 Vrms max, +1.5 to 2.0 Vpc

Measuring circuit

[Criteria] Shall not exceed the values specified in the item 3.

4.3 Leakage current (L.C.)

[Conditions] DC leakage current shall be measured with rated voltage, which is applied through a resistor of 1,000 $\pm 10\,\Omega$ connected in series with the capacitors, at the end of a specified period after the capacitors reached the rated voltage across the terminals.

[Criteria]

Shall not exceed the values specified in the item 3.

4.4 Temperature characteristics

[Conditions]

unit ℃

Step	Temperature
1	+20±2
2	$-10\pm3, -25\pm3, -40\pm3$
3	+20±2
4	+105±2

Step 1: Measure capacitance and impedance (at $120 \text{Hz} \pm 10\%$).

Step 2: Measure impedance (at 100kHz±10%, 120Hz±10%).

Step 3: No measurement for the electrical characteristics.

Step 4: Measure capacitance, tan δ and leakage current.

[Criteria]

Step 2: Impedance: Shall not exceed the values specified in the item 3.

Impedance ratio shall not exceed the values shown in Table-1 attached.

4.5 Terminal strength

(1) Pull strength

[Conditions] The capacitor body shall be held. A force shall be gradually applied to the lead wire in the direction of the axis of the lead wire up to the specified pull force, and retained for 10 ± 1 seconds.

Nominal lead diameter mm	Pull force N
Over 0.5 to 0.8 incl.	10

[Criteria]

The lead wire shall neither loosen nor break away.

(2) Lead bending strength

[Conditions] The capacitor shall be held so that the normal axis of the lead wire can be in a vertical position. A weight equivalent to the specified load shall be hung on the end of the lead wire. The capacitor body shall be inclined through 90° and returned to its normal position within 2 to 3 seconds. The consecutive bend shall then be in the opposite direction in the same manner.

Nominal lead diameter mm	Bending load N
Over 0.5 to 0.8 incl.	5

[Criteria]

The lead wire shall neither loosen nor break away.

4.6 Vibration

[Conditions] Vibration frequency range

: 10 to 55Hz

Peak to peak amplitude

: 1.5mm

Sweep rate

: 10 to 55 to 10Hz in about 1 minute

Direction and period of motion

: 2 hours in each of 3 mutually perpendicular directions (total

of 6 hours)

Note: Capacitors shall be mounted on the pc board with their lead wires anchored at 4mm max. of their bodies, except for the capacitors with the case size ϕ 16 \times 30L, whose lead wire shall be anchored at 1mm max. of their bodies. The body of the capacitor with 12.5mm or larger in diameter or 25mm or longer in length, in addition, shall be anchored to the pc board with a fixture.

[Criteria]

Capacitance (during test)

: The reading shall be stable.

Appearance

: No significant damage.

Capacitance change

: Shall be within $\pm 5\%$ of the initial measured value.

4.7 Solderability

[Conditions] Type of solder : Sn-3Ag-0, 5Cu

> Flux : Ethanol solution (25 wt. % rosin)

Solder temperature : +245±3℃

Depth of immersion : Up to 1.5 to 2.0mm

Speed of immersion : 1.5mm/sec.

[Criteria] Solder shall cover at least 3/4 of the lead surface immersed.

4.8 Soldering heat

[Conditions] Type of solder : Sn-3Ag-0, 5Cu

> Flux : Ethanol solution (25 wt. % rosin)

Solder temperature/immersion time : $+260\pm5$ °C for 10 ± 1.0 seconds or $+380\pm10$ °C for 3 ± 0.5

Depth of immersion : Up to 1.5 to 2.0mm from the root of the lead wire covered

with a thermal screen.

Speed of immersion

: 25±2,5mm/sec.

[Criteria]

Appearance : No significant damage.

Leakage current : Shall not exceed the initial specified value. Capacitance change : Shall be within $\pm 10\%$ of the initial measured value.

Tan δ : Shall not exceed the initial specified value.

4.9 Operation of pressure relief vent

[Conditions] Apply a reverse voltage with DC current 1 amp. (DC reverse voltage test)

When the pressure relief vent operated, the capacitor shall not flame although gas generation or [Criteria]

expulsion of a part of the inside element is allowable.

If the vent does not operate with the voltage applied for 30 minutes, the test is considered to be

4.10 Humidity exposure

[Conditions] Test temperature : +40±2℃

Relative humidity : 90 to 95%RH Test time : 240±8 hours

[Criteria] Appearance : No significant damage

> Leakage current : Shall not exceed the initial specified value. Capacitance change : Shall be within $\pm 20\%$ of the initial measured value. Tan δ : Shall not exceed 120% of the initial specified value.

4.11 Endurance

 $[Conditions] \quad \hbox{After the capacitors are subjected to DC voltage with the rated ripple current applied for the specified} \\$

periods of time at $\pm 105\pm 2^{\circ}\mathrm{C}$, the following specifications shall be satisfies when the capacitors are restored to $\pm 20^{\circ}$ C. The sum of DC voltage and peak AC voltage must not exceed their full rate

voltage.

: 6,000⁺⁷²0 hours Specified test time

[Criteria] Leakage current : Shall not exceed the initial specified value.

> Capacitance change : Shall be within $\pm 25\%$ of the initial measured value. Tan δ : Shall not exceed 200% of the initial specified value.

4.12 Shelf life

[Conditions] The capacitor shall be subjected to $\pm 105 \pm 2^{\circ}$ C for $500^{\pm 24}$ hours without voltage applied, and the

capacitor is then restored at $\pm 20^{\circ}\!\text{C}$ for the measurements. Before the measurements, the capacitor

shall be preconditioned by applying voltage according to item 4.4 of JIS C 5102.

[Criteria] Leakage current : Shall not exceed the initial specified value.

> Capacitance change : Shall be within $\pm 25\%$ of the initial measured value. Tan δ : Shall not exceed 200% of the initial specified value.

5. Others

5.1 Table

Table-1

Rated voltage VDC	25
Z-25℃/Z+20℃	2
Z-40℃/Z+20℃	3

5.2 Multipliers for ripple current

Frequency multipliers

Frequency Capacitance	120Hz	1kHz	10kHz	100kHz
1000 μF	0.60	0.87	0. 95	1.00

When frequency is different from the specified condition shown in the item 3, do not exceed the value obtained by multiplying the permissible maximum ripple current by the multiplier above.

5.3 Export Trade Control Ordinance (When our product our is exported from Japan)

1. Export Trade Control Ordinance (Section 1 through 15 of Appendix Table 1)

Export regulation of the capacitors for pulse use (750V or higher) and the capacitors for high voltage (5,000V or higher) is carried out in (item 41-4) in Section 2 of Appendix Table 1 (Section 49 in Chapter 1 of METI's Ordinance) and (item 7) in Section 7 of Appendix Table 1 (Section 6 in Chapter 6 of METI's Ordinance). Therefore, the aluminum electrolytic capacitors are not applicable to Export Trade Control Ordinance. However, the aluminum electrolytic capacitors, which are described in this specification, don't fulfill the regulated level. Therefore, the aluminum electrolytic capacitors are not applicable to Export Trade Control Ordinance.

2. Export Trade Control Ordinance (Section 16 of Appendix Table 1)

The aluminum electrolytic capacitors, which are described in this specification, applicable to goods under Export Regulations (Category 85 of Appendix Table in Customs Tariff Law) based on Section 16 of Appendix Table 1 in Export Trade Control Ordinance.

If the exporter got information that their exporting goods are used to any development of massive weapon, the exporter must apply for exporting permission to Ministry of Economy, Trade and Industry (METI), and get METI's approval.

Regardless of the above, if the exporter is notified by METI that his/her exporting goods are potentially used to any development of extensive destructive weapons, the exporter seek permission from METI to export, and get METI's approval. When Nippon Chemi-Con receives such notice from METI, we will inform it to your company.

5.4 Cleaning of assembly boards

These products are not solvent-proof type capacitors.

5.5 Manufacturing site

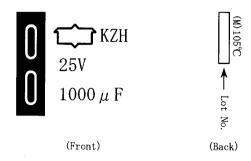
CHEMI-CON IWATE CORPORATION
P. T. INDONESIA CHEMI-CON
TAIWAN CHEMI-CON
SAMYOUNG ELECTRONICS CO., LTD.
QINGDAO SAMYOUNG ELECTRONICS CO., LTD.
CHEMI-CON (WUXI) CO., LTD.

6. Marking

The following items shall be marked on each capacitor. (White marking on brown sleeve)

- ①Rated voltage
- (5) Manufacturer's identification mark
- ②Nominal capacitance
- ⑥Capacitance tolerance (M)
- 3Maximum operating temperature
 4Polarity
- 7Lot No.

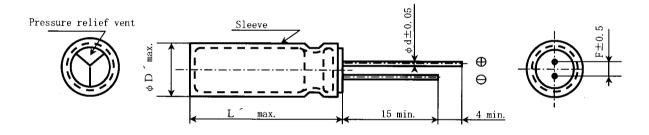
(Example)



7. Dimension and construction

7.1 Dimension Long lead

unit mm

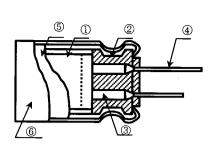




φD	10
L	20
φd	0.6
F	5. 0
L´	L+1.5 %1
φD´	φD+0.5 <u>%</u> 1

 \divideontimes 1 ϕ D, L : nominal case size

7.2 Construction



	Compositions		Materials	
① Element		Anode foil	Aluminum	
	Flowers	Cathode foil	Aluminum	
	Element	Separator	Paper	
		Fixing tape	Polypropylene(PP)	
2	Seal		Rubber	
3	Aluminum tab		Aluminum	
4	Lead wire		Tinned copper clad steel	
(5)	Case		Aluminum	
6	Sleeve		Polyester	

No ozone depleting substance has been used. RoHS Compliant Halogen-Free

8. Substance Requirements

All homogeneous materials within a component or product must meet the criteria in Table-1, and Table-2. A homogeneous material has uniform composition throughout and cannot be mechanically disjointed into different materials.

Table-1: Substance restrictions for halogen-free products.

Substance	Permissible Limit (by weight)
Bromine (Br)	≤900ppm (0.09%)
Chlorine (Cl)	≤900ppm (0.09%)
Total concentration of Chlorine (C1) + Bromine (Br)	≦1500ppm (0.15%)

Table-2: Additional substance restrictions.

Substance	Permissible Limit (by weight)	
Antimony Trioxide (Sb ₂ O ₃)	≤1000ppm (0.1%)	
Red Phosphorus	≤1000ppm (0.1%)	

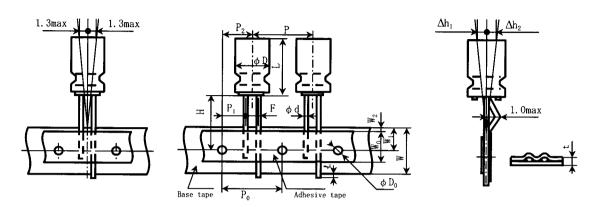
9. Taping

9.1 Scope

This specification is applied to radial lead type aluminum electrolytic capacitors which are taped according to JIS C 0805-1989.

9.2 Taping configurations

TD type



9.3 Taping dimensions

unit mm

			unit iiii
Symbol	Tolerance	Nominal value	Remarks
φD	φD — 10		
L	L — 20		
φd	±0.05	0.6	
Р	±1.0	12. 7	
P ₀	±0.3	12.7	% 1
P_1	±0.7	3. 85	※ 2
P_2	±1.3	6. 35	
F	-0.2/+0.8	5, 0	※ 2
W	±0.5	18. 0	
Wo	min.	12. 5	※ 3
W ₁	±0.5	9. 0	
\mathbf{W}_2	max.	1.5	※ 3
Н	-0/+2.0	18. 0	
φ D _o	±0.2	4. 0	
Q	max.	1.0	
t	±0.2	0.7	
Δh1, Δh2	max.	2. 0	¾ 4

³¹ Cumulative pitch error shall not exceed ± 1.0 mm per 20 pitches.

 $[\]frak{\%}2$ Measurement shall be made at the top of the tape and the center of the lead.

 $[\]divideontimes 3$ Adhesive tape shall not extend beyond the edge of the base tape.

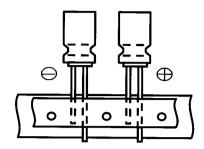
 $[\]ensuremath{\%4}$ Measurement shall be made at the top to the capacitor.

9.4 Taping method and polarity

(1) Taping method

Capacitors shall be taped on the base tape with the adhesive tape so that their lead wires can be perpendicular to the longitudinal direction of the base tape, and their polarities shall be arranged in one orientation.

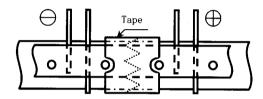
 \divideontimes The polarity orientation does not apply to non-polarized capacitors.



(2) Splicing of base tapes

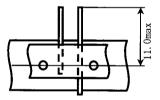
Splicing shall be made with a tape by means of a prescribed tool as shown below. The base tapes spliced shall be aligned within a error of 1.0mm. The splicing joint shall not have capacitors.

 \divideontimes The polarity orientation does not apply to non-polarized capacitors.



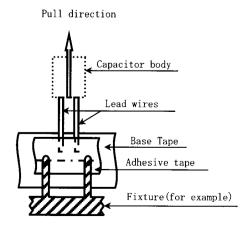
(3) Missing of capacitor

Consecutive missing capacitors shall not exceed 3 pcs after taped. Although a quantity of discontinuous missing capacitors is not specified, the total quantity per a box shall be satisfied. When a capacitor is removed from the tape after taped, its lead wires shall be cut off or the capacitor shall be pulled out. Cutting the lead wires shall be made as follows.



(4) Pull strength of taped capacitor

The capacitor which was fixed in between the base tape and adhesive tape shall have adhesion of at least 5N when the capacitor was pulled out in the axis direction of the capacitor as follows.

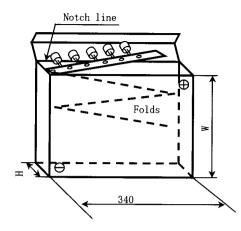


Nippon Chemi-Con Corporation

10. Packaging

10.1 Packaging for taping

unit mm



Case siz	e (φD×L)	W	Н	Quantity packed
	(pcs)			
φ 10	length 20	308	62	800

Note: The box dimensions may change slightly.

% ϕ 10 the capacitors located on folds shall be removed.

(The polarity orientation does not apply to non-polarized capacitors.)

The following items shall be marked on the box.

- 1) Taping code
- 5) Quantity
- 2) Series name
- 6) Customer-required marking (Where customers designated.)
- 3) Part description
- 7) Customer Part No. (Where customers designated.)
- 4) Production drawing No.
- 8) Lot No. (Assembly lot No. of capacitor.)

CLASSIFICATION	ITEM	
1. Designing		
device	and operating environments are within the lated performance limits of	
circuits.	capacitors prescribed in their catalogs or product specifications, and select the capacitors to mee	
olioures.	the service life of a device. Do not use capacitors at the following conditions,	
	a) High temperature (exceeding the maximum rated operating temperature of capacitors)	
	b) Excessive current (more than the rated permissible rated ripple current of the capacitors)	
	c)Over-voltage (exceeding the rated voltage of the capacitors) d)Reverse voltage or AC voltage.	
	e) In circuits in which charge and discharge are frequently repeated.	
	(2) Electrically isolate the outer can case of a capacitor from the positive and negative terminals and	
	the circuits. If the capacitor has a dummy terminal for mounting stability, isolate it as well.	
	(3) The outer sleeves of capacitors are not assured as insulation —functioning pars. Do not use the	
	capacitors for places that require the outer sleeves functioning as insulation.	
	(4) Do not use capacitors to devices exposed to the following environment.	
	a) Water, salt water or oil spatters, or dewy places.	
i i	b) Toxic gas (hydrogen sulfide, sulfurous acid, nitrous acid, chlorine, ammonium, etc.) fills into.	
	c)Direct sunlight, ozone, ultraviolet rays or radiation is applied to.	
	d)Severe vibration or mechanical shock exceeding the limits prescribed in the catalogs or product	
	specifications is applied to.	
	(5) Design considerations for installing a capacitor to the print circuit board.	
	a)Provide the appropriate hole spacing on the printed circuit board to match the terminal spacing	
	of the capacitor.	
	b)Make an open space over the pressure relief vent of the capacitor.	
	c)Do not locate any wire or copper trace over the vent.	
	d) If mounting the capacitor with its vent face down on the pc board, provide a ventilation hole in	
	the pc board in place. (Application for CEO4 type.)	
	e)Do not locate any copper trace under the seal side of a capacitor.	
	f) Avoid locating any heat-producing object around a capacitor or on the reverse side of the print	
	circuit board under the capacitor.	
	g) For surface mount capacitors, design the copper pads of a print circuit board according to the product	
	specifications.	
	(6) Other precautions in designing devices.	
	a) Take account of the changes in the electrical characteristics of capacitors varying with respect	
	to temperature and frequency.	
	b) If using a double-sided printed circuit board, do not locate any via hole within the pc board area	
	under the seal side of the capacitor.	
	c) If using more than one capacitor to connect in parallel, balance the currents flowing into the	
	individual capacitors.	
	d) If using more than one capacitor to connect in series, connect resistors in parallel with the	
	individual capacitors for balancing the voltages.	
2. Installing	(1) Follow the instructions below for installing capacitors in devices.	
capacitors in	a)Do not re-use the capacitors already used in devices. The used capacitors are not reusable, except	
devices.	the case that they are taken from a device for periodic inspection measuring their electrical	
	characteristics and then returned to the device.	
	b) Although discharged at manufacturing process, capacitors may have been re-charged by a recovery	
	voltage phenomenon. In this case, discharge them through a resistor of approximately 1 k Ω before	
	installation.	
	c) The capacitors that has been stored for long periods of time may have high leakage current. In this	
	case, make pre-conditioning by applying a voltage through a resistor of approximately	
	$1k\Omega$.	
	d)Make sure of the rated values (nominal capacitance and voltage) and polarity when installation.	
	e)Do not drop capacitors on the floor etc. If they should fall down, do not use them.	
	f)Do not deform capacitors in installing to a device.	
	g) Make sure that the terminal spacing equals the hole spacing of the pc board before installation.	
	h) If the lead wires of the capacitor are clinched to the pc board with the clinch unit of an automatic	
	insertion machine, adjust the clinch unit not to apply an excessive lead pull force to the lead	
	wires of the capacitor.	
	i) Note a mechanical shock that is caused by the vacuum head, component checker or centering operation	
 	of an automatic insertion or mounting machine.	
'	(2) Follow the instructions below for soldering. a) Do not put flux on any part of capacitors other than their terminals.	
	argo not put till on any part of capacitors other than their terminals	
l l	b)Soldering conditions (temperature, time and the number of repeats) should be within the limits	
	b) Soldering conditions (temperature, time and the number of repeats) should be within the limits prescribed in the catalogs or product specifications.	
	b)Soldering conditions (temperature, time and the number of repeats) should be within the limits	

CLASSIFICATION	ITEM			
2. Installing	(3) Do not apply a mechanical stress to the capacitor after soldering to the pc board.			
capacitors in	a) Do not incline, twist or push the capacitor body.			
devices.	b)Do not take the assembly board by the capacitor in lifting or carrying the assembly board.			
	c)Do not bump or strike any object against the capacitor.			
	(4) Do not wash capacitors by using cleaning agents. If it is necessary to wash capacitors, use the only			
	capacitors that are capable of withstanding the cleaning agents and apply the cleaning conditions			
	within the limits prescribed in the product specifications.			
	(5) Precautions for the washable capacitors.			
	a)Prevent cleaning agents from being contaminated, by controlling their conductivity, pH, specific			
	gravity, water content, etc.			
	b)After washing the capacitors, do not keep them in an atmosphere of the cleaning agents or a closed			
	container. Remove the residual cleaning agents by drying the assembly board by a forced hot air			
	at temperatures less than the maximum rated operating temperature of the capacitors .			
	(6) Do not use any adhesive or coating material containing halogenated solvents.			
	(7) Precautions for using adhesives and coating materials.			
	a) Do not apply adhesives or coating materials with flux or dirt left on the rubber seal of the capacitor			
	or between the pc board surface and the capacitor seal.			
	b)Before applying the adhesives or coating materials to the capacitors, dry and remove the residual			
	cleaning agents. Also, do not cover up the whole surface of the capacitor rubber seal with the			
	adhesives or coating materials.			
	c)For permissible heat conditions for curing adhesives or coating materials, follow the instructions			
	in the product specifications of capacitors.			
3. During	1) Follow the following precautions for a device in operation.			
operation.	a)Do not touch a capacitor directly with bare hands.			
	b)Do not short-circuit the terminals of a capacitor by applying any conductive object.			
	(2) Do not use devices at the following environment.			
	a)Water, oil or dew spatters on the capacitors.			
	b)Direct sunlight, ozone, ultraviolet rays or radiation is applied to the capacitors.			
	c)Toxic gas (hydrogen sulfide, sulfurous acid, nitrous acid, chlorine, ammonium, etc.) fills into.			
	d)Severe vibration or mechanical shock, exceeding the limits prescribed in the catalogs or product			
	specifications, is applied to the capacitors.			
4. Maintenance	(1) Make periodic inspections for the capacitors that have been used in devices for industrial			
inspection.	application. The appearance and electrical characteristics of the capacitors should be checked for			
•	the periodic inspections.			
5. In the event	(1) If the capacitor should blow out gas with its vent open, turn off or unplug the main power supply			
of venting on	of the device.			
capacitors.	(2) When venting, the capacitor blows a hot gas of more than 100°C. Never expose the face close to the			
-	venting capacitor. If you should expose your eyes to the spouting gas and inhale it, immediately flush			
	the open eyes and gargle with water. Do not lick the electrolyte of a capacitor. Wash the electrolyte			
	away from the skin with soap and water.			
6. Fumigation.	(1) Fumigation process may be required when exporting the end electrical product. The process, actually			
	halogenated ions, may cause the aluminum electrolytic capacitor to corrode. The fumigation solvent			
	must not directly adhere to the electrical product and the solvent must be dried completely. Please			
	consult us if solvent adheres to the aluminum electrolytic capacitors or drying condition is not			
	satisfaction.			
7. Storage.	(1) Store capacitors indoors at a temperature of 5 to 35℃ and a humidity of less than 75%RH.			
	(2) Do not store capacitors in the environment prohibited with Section3. (2).			
8. Disposal.	(1) In the interests of the environment and in order to comply with local disposal regulations, ask a			
o. Bioposai.	specialist for the disposal of industrial wastes.			
	· · · · · · · · · · · · · · · · · · ·			
	a)Burn capacitors after crushing parts of making a hole on the capacitor body.b)If you do not burn, ask a specialist for the disposal of industrial wastes.			

* For other precautions and the details of these precautions, refer to Engineering Bulletin No. 634A. The following technical terms have been changed according to change of reference standard from JIS C 5141-1991 to JIS C 5101-1998.

New standard JIS C 5101-1998	Old standard JIS C 5141-1991	
Category temperature range	Operating temperature range	
Rated ripple current	Ripple current	
Endurance	Load life	